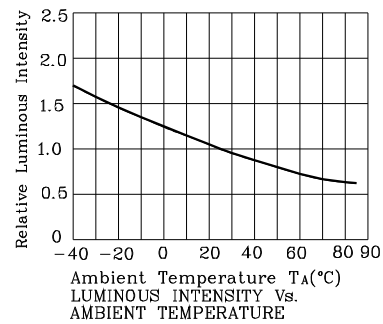
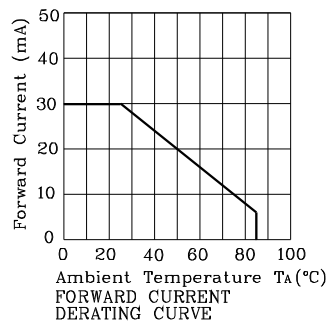
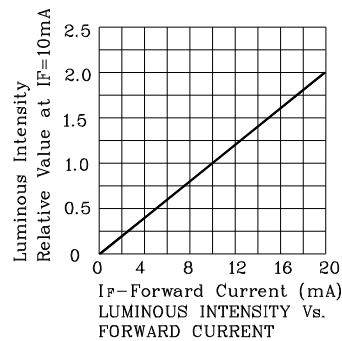
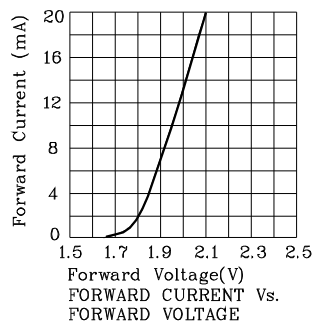


❖ UY



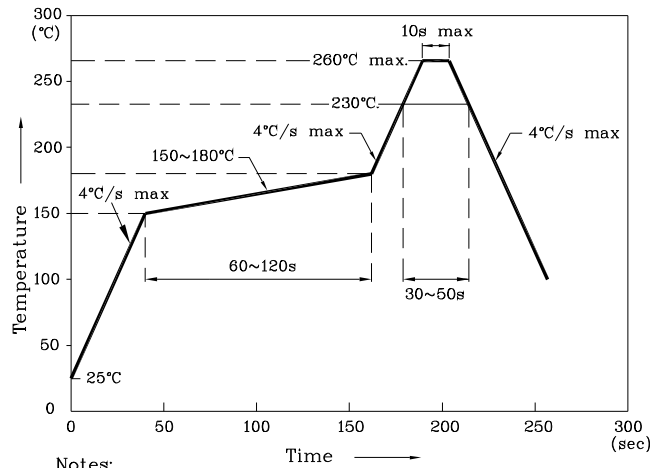
Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity/ luminous flux or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm
2. Luminous Intensity/ Luminous Flux: +/-15%
3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

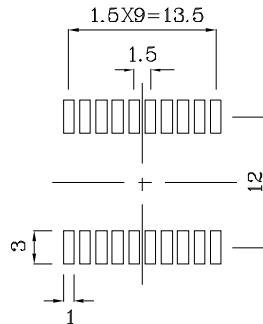
Reflow Soldering Profile For Lead-free SMT Process.



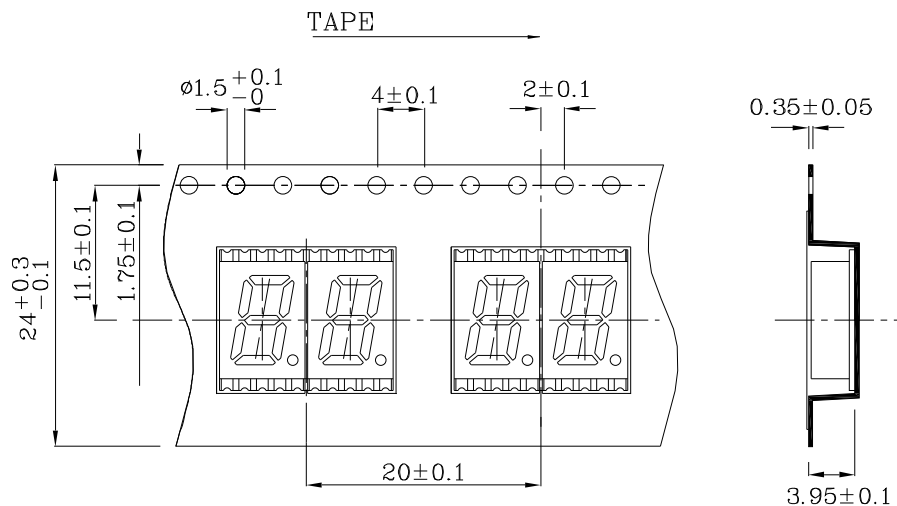
Notes:

1. Maximum soldering temperature should not exceed 260°C.
2. Recommended reflow temperature: 145°C-260°C.
3. Do not put stress to the epoxy resin during high temperatures conditions.

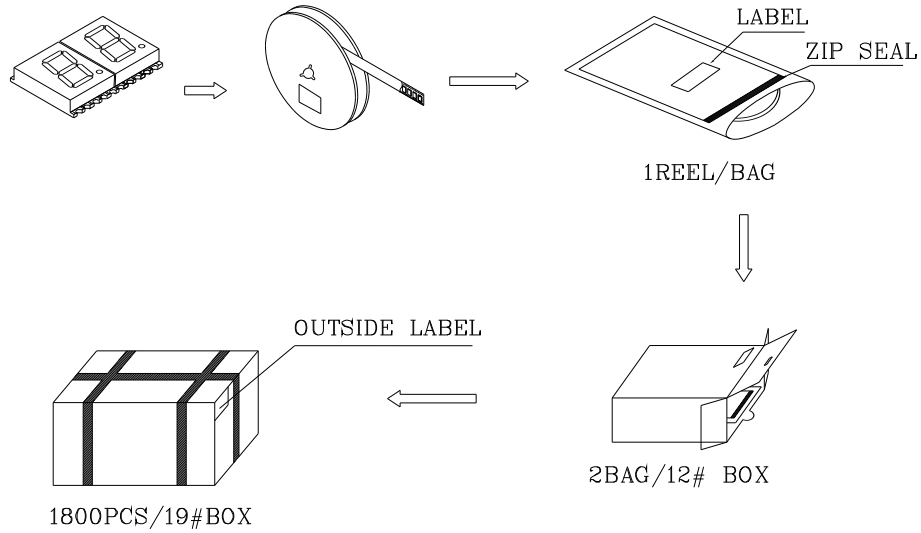
❖ Recommended Soldering Pattern (Units : mm;Tolerance:± 0.15)



❖ Tape Specification (Units : mm)

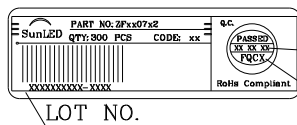


PACKING & LABEL SPECIFICATIONS ZFUY07C2

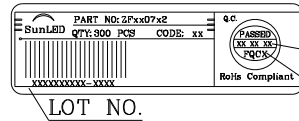


Outside LABEL Paste On The BAG

Inside LABEL Paste On The TAPE



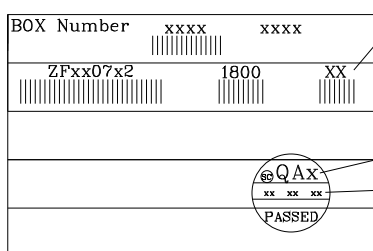
Date  
Number OF FQC



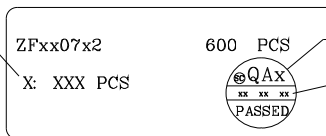
Date  
Number OF FQC

Outside LABEL Paste On The 19#Box

Outside LABEL Paste On The 12#Box



BIN CODE  
Number OF QA  
Date



Number OF QA  
Date